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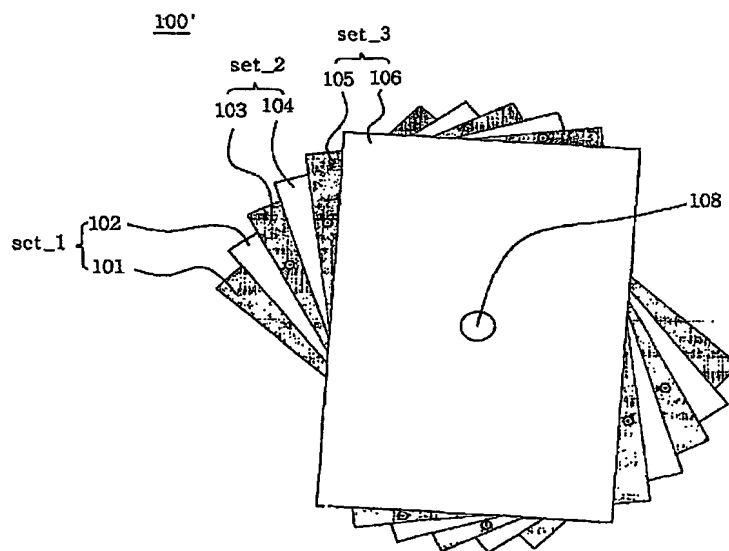
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(54) Title: A METHOD FOR MANUFACTURING A LENS ASSEMBLY OF MICROCOLUMN AND A LENS ASSEMBLY OF MICROCOLUMN MANUFACTURED BY THE SAME



(57) Abstract: The present invention provides a method for manufacturing a lens assembly of a microcolumn having a plurality of microlenses and a plurality of insulating layers alternately interposed between the microlenses. The method includes forming at least one first microlens assembly set (set_1) by anodic-bonding an insulating layer (101) and a microlens (102) together; layering a second microlens assembly set (set_2) on the first microlens assembly set (set_1); and scanning a laser beam, thus welding the first microlens assembly set (set_1) to the microlens of the second microlens assembly set (set_2). The method of the present invention further includes anodic-bonding the microlens assembly sets together.